

# TPS54334EVM-722 3-A Regulator Evaluation Module

This user's guide contains background information for the TPS54334 as well as support documentation for the TPS54334EVM-722 evaluation module (PWR722-001). Also included are the performance specifications, the schematic, and the bill of materials for the TPS54334EVM-722.

#### Contents

1	Introduction	2
2	Test Setup and Results	
3	Board Layout	
4	Schematic and Bill of Materials	14
	List of Figures	
1	TPS54334EVM-722 Efficiency	. 5
2	TPS54334EVM-722 Low Current Efficiency	5
3	TPS54334EVM-722 Load Regulation	6
4	TPS54334EVM-722 Line Regulation	6
5	TPS54334EVM-722 Transient Response	. 7
6	TPS54334EVM-722 Loop Response	. 7
7	TPS54334EVM-722 Output Ripple, I <sub>OUT</sub> = 3 A	. 8
8	TPS54334EVM-722 Output Ripple, I <sub>OUT</sub> = 200 mA	. 8
9	TPS54334EVM-722 Output Ripple, I <sub>OUT</sub> = 0 A	. 8
10	TPS54334EVM-722 Input Ripple	9
11	TPS54334EVM-722 Startup Relative to V <sub>IN</sub>	10
12	TPS54334EVM-722 Startup Relative to Enable	10
13	TPS54334EVM-722 Shutdown Relative to V <sub>IN</sub>	11
14	TPS54334EVM-722 Shutdown Relative to EN	11
15	TPS54334EVM-722 Top-Side Assembly	12
16	TPS54334EVM-722 Top-Side Layout 3	13
17	TPS54334EVM-722 Bottom-Side Layout	13
18	TPS54334EVM-722 Schematic	14
	List of Tables	
1	Input Voltage and Output Current Summary	. 2
2	TPS54334EVM-722 Performance Specification Summary	. 2
3	Output Voltages Available	3
4	EVM Connectors and Test Points	4
5	TPS54334FVM-722 Bill of Materials	15



Introduction www.ti.com

#### 1 Introduction

This user's guide contains background information for the TPS54334 as well as support documentation for the TPS54334EVM-722 evaluation module (PWR722-001). Also included are the performance specifications, the schematic, and the bill of materials for the TPS54334EVM-722.

### 1.1 Background

The TPS54334 dc/dc converter is designed to provide up to a 3-A output from an input voltage source of 4.2 V to 28 V. Rated input voltage and output current range for the evaluation module are given in Table 1. This evaluation module is designed to demonstrate the small printed-circuit-board areas that may be achieved when designing with the TPS54334 regulator. The switching frequency is externally set at a nominal 570 kHz. The high-side and low-side MOSFETs are incorporated inside the TPS54334 package along with the gate-drive circuitry. The low drain-to-source on resistance of the MOSFETs allow the TPS54334 to achieve high efficiencies and helps keep the junction temperature low at high output currents. The compensation components are external to the integrated circuit (IC), and an external divider allows for an adjustable output voltage. Additionally, the TPS54334 provides an adjustable undervoltage lockout input. The absolute maximum input voltage is 30 V for the TPS54334EVM-722.

**Table 1. Input Voltage and Output Current Summary** 

EVM	INPUT VOLTAGE RANGE	OUTPUT CURRENT RANGE		
TPS54334EVM-722	VIN = 4.2 V to 28 V	0 A to 3 A		

# 1.2 Performance Specification Summary

A summary of the TPS54334EVM-722 performance specifications is provided in Table 2. Specifications are given for an input voltage of  $V_{IN}$  = 24 V and an output voltage of 5.0 V, unless otherwise specified. The TPS54334EVM-722 is designed and tested for  $V_{IN}$  = 4.2 V to 28 V. The ambient temperature is 25°C for all measurements, unless otherwise noted.

Table 2. TPS54334EVM-722 Performance Specification Summary

Specification	Test Co	Test Conditions		TYP	MAX	Unit
V <sub>IN</sub> operating voltage range			4.2	24	28	V
V <sub>IN</sub> start voltage				4.1		V
V <sub>IN</sub> stop voltage				3.9		V
Output voltage set point				3.3		V
Output current range <sup>(1)</sup>	V <sub>IN</sub> = 4.2 V to 28 V		0		3	Α
ine regulation $I_0 = 1.5 \text{ A}, V_{IN} = 4.2 \text{ V} \text{ to } 28 \text{ V}$			±0.05%			
Load regulation	$V_{IN} = 12 \text{ V}, I_{O} = 0 \text{ A to}$	$V_{IN} = 12 \text{ V}, I_{O} = 0 \text{ A to } 3 \text{ A}$		±0.2%		
	I <sub>O</sub> = 0.75 A to 2.25 A	Voltage change		-190		mV
Lood top as in the same as		Recovery time		150		μs
Load transient response	L 0.05 A 1- 0.75 A	Voltage change		190		mV
	$I_0 = 2.25 \text{ A to } 0.75 \text{ A}$	Recovery time		150		μs
Loop bandwidth	$V_{IN} = 24 \text{ V}, I_{O} = 1.5 \text{ A}$	V <sub>IN</sub> = 24 V, I <sub>O</sub> = 1.5 A		54.26		kHz
Phase margin	Phase margin $V_{IN} = 24 \text{ V}$ , $I_O = 1.5 \text{ A}$			82		0
Input ripple voltage	I <sub>O</sub> = 3 A	I <sub>O</sub> = 3 A		400		$mV_{PP}$
Output ripple voltage	ole voltage $I_0 = 3 \text{ A}$			<30		$mV_{PP}$
Output rise time				2		ms
Operating frequency				570		kHz
Maximum Efficiency TPS54334EVM-722, $V_{IN} = 12 \text{ V}$ , $I_O = 1 \text{ A}$				91.38%		

 $<sup>^{(1)}</sup>$  When  $V_{\text{IN}}$  = 4.2 V, maximum  $I_{\text{OUT}}$  is 2 A.



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#### 1.3 Modifications

These evaluation modules are designed to provide access to the features of the TPS54334. Some modifications can be made to this module.

#### 1.3.1 Output Voltage Set Point

The voltage divider, R5 and R6, is used to set the output voltage. To change the output voltage of the EVM, it is necessary to change the value of resistor R6. Changing the value of R6 can change the output voltage above 0.8 V. The value of R6 for a specific output voltage can be calculated using Equation 1. Use  $31.6 \text{ k}\Omega$  for R5.

$$R6 = \frac{R5 \times 0.8 \text{ V}}{V_{\text{OUT}} - 0.8 \text{ V}}$$
 (1)

Table 3 lists the R5 and R6 values for some common output voltages. Note that  $V_{IN}$  must be in a range so that the minimum on-time is greater than 145 ns, and the maximum duty cycle is less than 100%. The values given in Table 3 are standard values, not the exact value calculated using Equation 1.

Output Voltage (V)	R5 Value (kΩ)	R6 Value (kΩ)
1.8	31.6	25.5
2.5	31.6	15
3.3	31.6	10

**Table 3. Output Voltages Available** 

# 1.3.2 Adjustable UVLO

The under voltage lock out (UVLO) can be adjusted externally using R1 and R2. The EVM is set for a start voltage of 4.1 V and a stop voltage of 3.23 V using R1 = 220 k $\Omega$  and R2 = 84.5 k $\Omega$ . Use Equation 2 and Equation 3 to calculate required resistor values for different start and stop voltages. Considering the V<sub>IN</sub> UVLO, the stop voltage is set to 3.9 V.

R1 = 
$$\frac{V_{START} \left( \frac{V_{ENFALLING}}{V_{ENRISING}} \right) - V_{STOP}}{I_{p} \left( 1 - \frac{V_{ENFALLING}}{V_{ENRISING}} \right) + I_{h}}$$
(2)

$$R2 = \frac{R1 \times V_{ENFALLING}}{V_{STOP} - V_{ENFALLING} + R1(I_p + I_h)}$$
(3)

$$I_D = 1.15 \mu A$$
,  $I_h = 3.3 \mu A$ ,  $V_{ENFALLING} = 1.17 V$  and  $V_{ENRISING} = 1.21 V$ 



Test Setup and Results www.ti.com

# 2 Test Setup and Results

This section describes how to properly connect, set up, and use the TPS54334EVM-722 evaluation module. The section also includes test results typical for the evaluation module and covers efficiency, output voltage regulation, load transients, loop response, output ripple, input ripple, and start-up.

# 2.1 Input/Output Connections

The TPS54334EVM-722 is provided with input/output connectors and test points as shown in Table 4. A power supply capable of supplying 2 A must be connected to J1 through a pair of 20-AWG wires. The load must be connected to J4 through a pair of 20-AWG wires. The maximum load current capability must be at least 4 A to use the full capability of this EVM. Wire lengths must be minimized to reduce losses in the wires. Test-point TP1 provides a place to monitor the  $V_{IN}$  input voltages with TP2 providing a convenient ground reference. TP6 is used to monitor the output voltage with TP7 as the ground reference.

**Table 4. EVM Connectors and Test Points** 

Reference Designator	Function
J1	VIN (see Table 1 for V <sub>IN</sub> range)
J2	VOUT, 3.3 V at 3 A maximum
JP1	2-pin header for enable. Connect EN to ground to disable, open to enable.
JP2	2-pin header for V <sub>DD</sub> . Connect VOUT to V <sub>DD</sub> as the power supply.
TP1	V <sub>IN</sub> test point at VIN connector
TP2	GND test point at VIN
TP3	PGOOD test point
TP4	PH test point
TP5	Test point between voltage divider network and output. Used for loop response measurements.
TP6	Output voltage test point at OUT connector
TP7	GND test point at VOUT connector
TP8	V <sub>DD</sub> test point at the VDD connector
TP9	GND test point at the VDD connector
TP10	EN test point



# 2.2 Efficiency

The efficiency of this EVM peaks at a load current of about 0.5 A – 1 A, and then decreases as the load current increases towards full load. Figure 1 shows the efficiency for the TPS54334EVM-722 at an ambient temperature of 25°C.

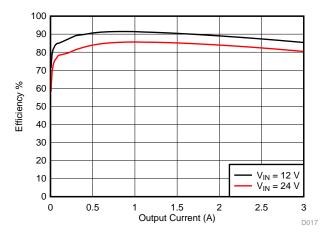


Figure 1. TPS54334EVM-722 Efficiency

Figure 2 shows the efficiency for the TPS54334EVM-722 on a semi-log scale to better show light load efficiency. The ambient temperature is 25°C.

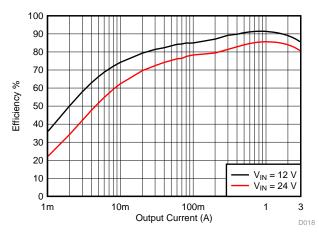


Figure 2. TPS54334EVM-722 Low Current Efficiency

The efficiency may be lower at higher ambient temperatures, due to temperature variation in the drain-to-source resistance of the internal MOSFET.

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#### 2.3 **Output Voltage Load Regulation**

Figure 3 shows the load regulation for the TPS54334EVM-722.

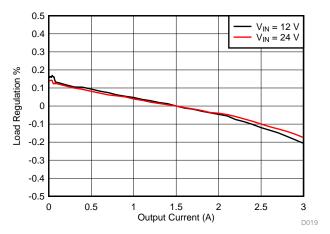


Figure 3. TPS54334EVM-722 Load Regulation

Measurements are given for an ambient temperature of 25°C.

#### 2.4 Output Voltage Line Regulation

Figure 4 shows the line regulation for the TPS54334EVM-722.

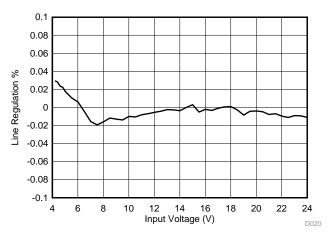


Figure 4. TPS54334EVM-722 Line Regulation

6



# 2.5 Load Transients

Figure 5 shows the TPS54334EVM-722 response to load transients. The current step is from 25% to 75% of maximum rated load at 12-V input. Total peak-to-peak voltage variation is as shown, including ripple and noise on the output.

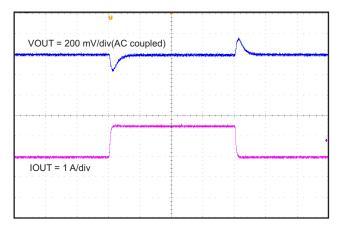


Figure 5. TPS54334EVM-722 Transient Response

# 2.6 Loop Characteristics

Figure 6 shows the TPS54334EVM-722 loop-response characteristics. Gain and phase plots are shown for  $V_{IN}$  voltage of 24 V. Load current for the measurement is 1.5 A.

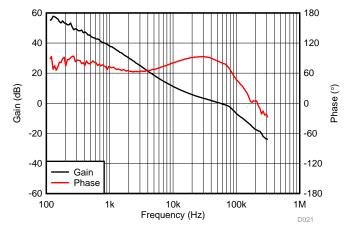


Figure 6. TPS54334EVM-722 Loop Response

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# 2.7 Output Voltage Ripple

Figure 7, Figure 8, and Figure 9 show the TPS54334EVM-722 output voltage ripple for full load, light load, and skip mode operation.  $V_{IN}$  = 12 V. The output The ripple voltage is measured directly across the output capacitors.

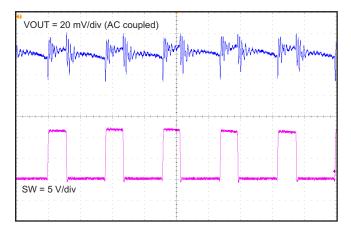


Figure 7. TPS54334EVM-722 Output Ripple,  $I_{OUT} = 3 A$ 

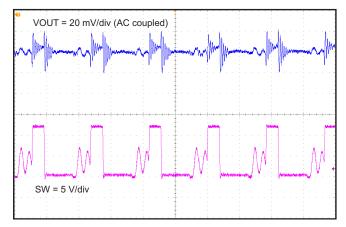


Figure 8. TPS54334EVM-722 Output Ripple,  $I_{OUT} = 200 \text{ mA}$ 

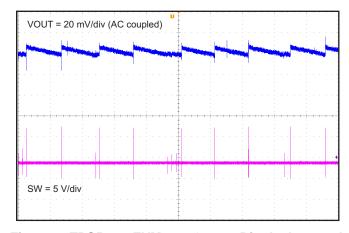


Figure 9. TPS54334EVM-722 Output Ripple,  $I_{OUT} = 0$  A



# 2.8 Input Voltage Ripple

Figure 10 shows the TPS54334EVM-722 input voltage ripple. The output current is the rated full load of 3 A and  $V_{\text{IN}}$  = 12 V. The ripple voltage is measured directly across the input capacitors.

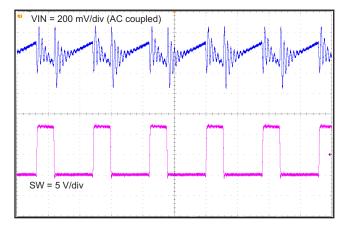


Figure 10. TPS54334EVM-722 Input Ripple



Test Setup and Results www.ti.com

# 2.9 Powering Up

Figure 11 and Figure 12 show the start-up waveforms for the TPS54334EVM-722. In Figure 11, the output voltage ramps up as soon as the input voltage reaches the UVLO threshold as set by the R1and R2 resistor divider network. In Figure 12, the input voltage is initially applied and the output is inhibited by using a jumper at JP1 to tie EN to GND. When the jumper is removed, EN is released. When the EN voltage reaches the enable-threshold voltage, the start-up sequence begins and the output voltage ramps up to the externally set value of 3.3 V. The input voltage for these plots is 12 V and the load is 5  $\Omega$ .

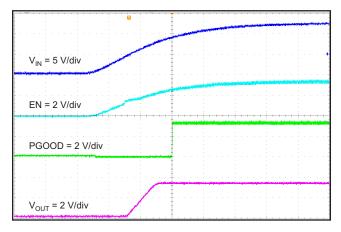


Figure 11. TPS54334EVM-722 Startup Relative to VIN

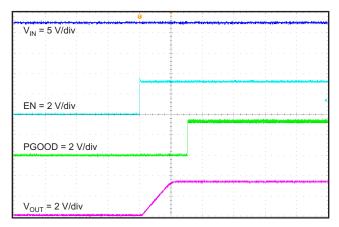


Figure 12. TPS54334EVM-722 Startup Relative to Enable



# 2.10 Powering Down

Figure 13 and Figure 14 show the start-up waveforms for the TPS54334EVM-722. In Figure 13, the output voltage ramps down as soon as the input voltage falls below the UVLO stop threshold as set by the R1 and R2 resistor divider network. In Figure 14, the output is inhibited by using a jumper at JP1 to tie EN to GND. The input voltage for these plots is 12 V and the load is  $2.2~\Omega$ .

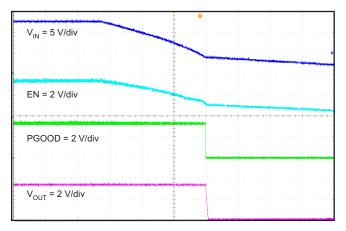


Figure 13. TPS54334EVM-722 Shutdown Relative to VIN

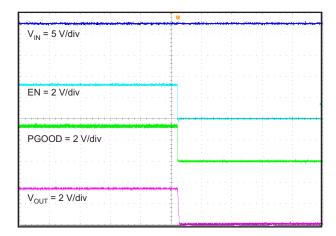


Figure 14. TPS54334EVM-722 Shutdown Relative to EN



Board Layout www.ti.com

# 3 Board Layout

This section provides a description of the TPS54334EVM-722, board layout, and layer illustrations.

### 3.1 Layout

Figure 15 through Figure 17 show the board layout for the TPS54334EVM-722. The topside layer of the EVM is laid out in a manner typical of a user application. The top and bottom layers are 2-oz. copper.

The top layer contains the main power traces for  $V_{IN}$ ,  $V_{OUT}$ , and VPHASE. Also on the top layer are connections for the remaining pins of the TPS54334 and a large area filled with ground. To facilitate the placement of the main input bypass capacitor as close to the  $V_{IN}$  and GND pins as possible, the trace for VPHASE is routed to the bottom layer immediately at the pin 3 connection. It is routed back to the top layer at the L1 inductor and C3 BOOT capacitor. The bottom layer contains a ground plane plus a copper fill area for VPHASE, an etch run to connect the upper resistor of the voltage set point divider to the regulation point at the J2 output connector, and a trace to connect the upper resistor of the UVLO set point divider network to  $V_{IN}$ . The top-side ground areas are connected to the bottom and internal ground planes with multiple vias placed around the board including four vias directly under the TPS54334 device to provide a thermal path from the top-side ground area to the bottom-side and internal ground planes.

The input decoupling capacitors (C2, and C1) and bootstrap capacitor (C3) are all located as close to the IC as possible. In addition, the voltage set-point resistor divider components are also kept close to the IC. For the TPS54334, an additional input bulk capacitor may be required, depending on the EVM connection to the input supply.

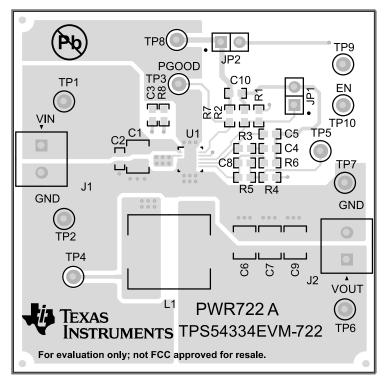


Figure 15. TPS54334EVM-722 Top-Side Assembly



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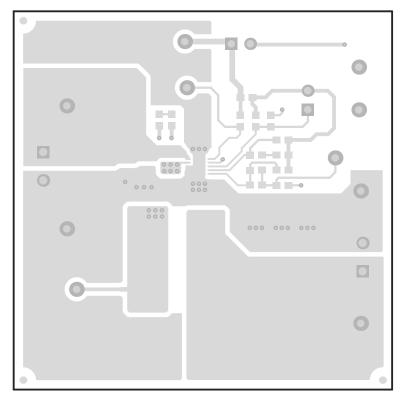


Figure 16. TPS54334EVM-722 Top-Side Layout 3

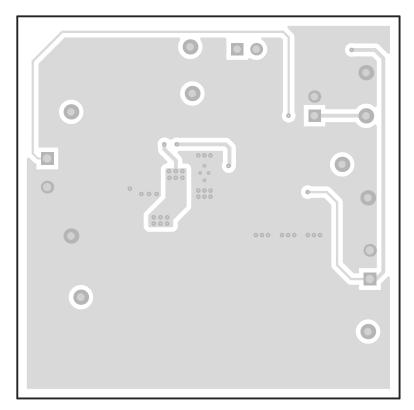


Figure 17. TPS54334EVM-722 Bottom-Side Layout



Schematic and Bill of Materials www.ti.com

# 4 Schematic and Bill of Materials

This section presents the TPS54334EVM-722 schematic and bill of materials.

# 4.1 Schematic

Figure 18 is the schematic for the TPS54334EVM-722.

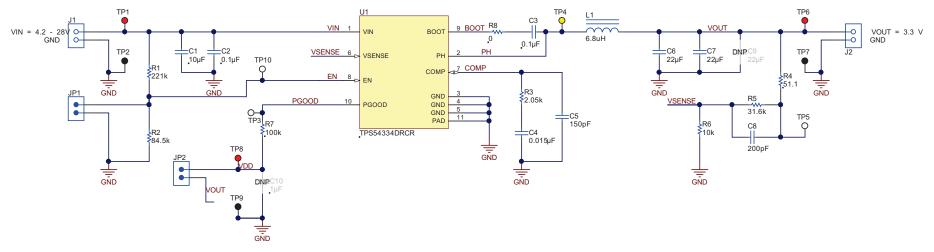


Figure 18. TPS54334EVM-722 Schematic



Schematic and Bill of Materials www.ti.com

#### 4.2 Bill of Materials

Table 5 presents the bill of materials for the TPS54334EVM-722.

# Table 5. TPS54334EVM-722 Bill of Materials

Designator	Qty	Value	Description	Package Reference	Part Number	Manufacturer
C1	1	10uF	CAP, CERM, 10uF, 35V, +/-10%, X7R, 1210	1210	GRM32ER7YA106KA12L	Murata
C2, C3	2	0.1uF	CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603	0603	GRM188R71H104KA93D	Murata
C4	1	0.015uF	CAP, CERM, 0.015 μF, 50 V, +/- 10%, X7R, 0603	0603	GRM188R71H153KA01D	Murata
C5	1	150pF	CAP, CERM, 150 pF, 50 V, +/- 5%, C0G/NP0, 0603	0603	GRM1885C1H151JA01D	Murata
C6, C7	2	22uF	CAP, CERM, 22 µF, 25 V, +/- 10%, X7R, 1210	1210	GRM32ER71E226KE15L	Murata
C8	1	200pF	CAP, CERM, 200 pF, 50 V, +/- 5%, C0G/NP0, 0603	0603	GRM1885C1H201JA01D	Murata
J1, J2	2	2x1	Conn Term Block, 2POS, 3.81mm, TH	PhoenixConact_1727010	1727010	Phoenix Contact
JP1, JP2	2		Header, TH, 100mil, 2x1, Gold plated, 230 mil above insulator	TSW-102-07-G-S	TSW-102-07-G-S	Samtec, Inc.
L1	1	6.8uH	Inductor, Shielded, Powdered Iron, 6.8 µH, 8 A, 0.0233 ohm, SMD	IHLP-4040DZ	IHLP4040DZER6R8M01	Vishay-Dale
R1	1	221k	RES, 221 k, 1%, 0.1 W, 0603	0603	RC0603FR-07221KL	Yageo America
R2	1	84.5k	RES, 84.5 k, 1%, 0.1 W, 0603	0603	CRCW060384K5FKEA	Vishay-Dale
R3	1	2.05k	RES, 2.05 k, 1%, 0.1 W, 0603	0603	CRCW06032K05FKEA	Vishay-Dale
R4	1	51.1	RES, 51.1 ohm, 1%, 0.1W, 0603	0603	CRCW060351R1FKEA	Vishay-Dale
R5	1	31.6k	RES, 31.6 k, 1%, 0.1 W, 0603	0603	CRCW060331K6FKEA	Vishay-Dale
R6	1	10k	RES, 10 k, 5%, 0.1 W, 0603	0603	CRCW060310K0JNEA	Vishay-Dale
R7	1	100k	RES, 100 k, 0.1%, 0.063 W, 0603	0603	CPF0603B100KE	TE Connectivity
R8	1	0	RES, 0 ohm, 5%, 0.1W, 0603	0603	CRCW06030000Z0EA	Vishay-Dale
SH-JP1	1	1x2	Shunt, 100mil, Gold plated, Black		382811-6	AMP
TP1, TP6, TP8	3	Red	Test Point, TH, Miniature, Red	Keystone5000	5000	Keystone
TP2, TP7, TP9	3	Black	Test Point, TH, Miniature, Black	Keystone5001	5001	Keystone
TP3, TP5, TP10	3	White	Test Point, TH, Miniature, White	Keystone5002	5002	Keystone
TP4	1	Yellow	Test Point, TH, Miniature, Yellow	Keystone5004	5004	Keystone
U1	1		4.2V TO 28V INPUT, 3A OUTPUT, SYNCHRONOUS SWIFT™ STEP DOWN VOLTAGE CONVERTER, DRC0010J	DRC0010J	TPS54334DRCR	Texas Instruments
C9	0	22uF	CAP, CERM, 22 µF, 25 V, +/- 10%, X7R, 1210	1210	GRM32ER71E226KE15L	Murata
C10	0	1uF	CAP, CERM, 1 µF, 50 V, +/- 10%, X5R, 0603	0603	GRM188R61H105KAALD	Murata
FID1, FID2, FID3	0		Fiducial mark. There is nothing to buy or mount.	Fiducial	N/A	N/A

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- 3 Regulatory Notices:
  - 3.1 United States
    - 3.1.1 Notice applicable to EVMs not FCC-Approved:

This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC - FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

#### **CAUTION**

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

#### FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

#### FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

#### **Concerning EVMs Including Radio Transmitters:**

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

#### Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

#### Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

#### Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

#### 3.3 Japan

- 3.3.1 Notice for EVMs delivered in Japan: Please see <a href="http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page">http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page</a> 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
  http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page
- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

- Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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- 4 EVM Use Restrictions and Warnings:
  - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
  - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
  - 4.3 Safety-Related Warnings and Restrictions:
    - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
    - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
  - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
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